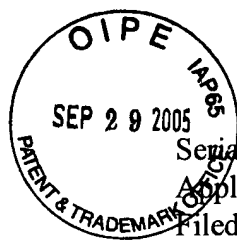


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/807,931  
Applicant: Douglas James Tweet *et al.*  
Filed: March 23, 2004  
Group #: 2812  
Examiner: Walter Lee Linsay, Jr.

Confirmation Number: 5155

Docket No: SLA.0586  
Customer No: 55376  
For: Method of Forming Local "Silicon-on-Nothing" or "Silicon-on-Insulator" Wafers  
with Tensile-strained Silicon

MS AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

**RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.111  
REQUEST FOR EXTENSION OF TIME IN WHICH TO RESPOND  
Change of Correspondence Address  
Introductory Comments**

In response to the Office Action dated June 9, 2005, please amend the above-identified Application as follows:

**Amendment to the Specification** None

**Amendment to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Amendment to the Drawings** begin on page 8 of this paper, and include an attached replacement sheet and an annotated sheet showing changes.

**Remarks/Arguments** begin on page 9 of this paper.

An **Appendix** including amended drawings figures is attached following page 11 of this paper.

10/04/2005 BABRAHA1 00000117 10807931  
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